

# NCE P-Channel Enhancement Mode Power MOSFET

## Description

The NCE01P30I uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

### **General Features**

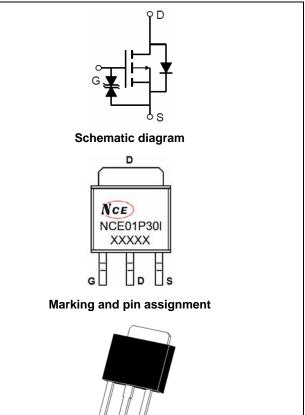
- V<sub>DS</sub> =-100V,I<sub>D</sub> =-30A
  R<sub>DS(ON)</sub> <58mΩ @ V<sub>GS</sub>=-10V (Typ:44mΩ)
  R<sub>DS(ON)</sub> <65mΩ @ V<sub>GS</sub>=-4.5V (Typ:48mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

### Application

• Portable equipment and battery powered systems

#### 100% UIS TESTED!

100% ΔVds TESTED!



TO-251 top view

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P30I	NCE01P30I	TO-251	-	-	-

### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	-100	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι <sub>D</sub>	-30	А	
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	-21	А	
Pulsed Drain Current	I <sub>DM</sub>	-150	А	
Maximum Power Dissipation	PD	120	W	
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	360	mJ	
Derating factor		0.8	W/℃	
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	°C	
Thermal Characteristic				
Thermal Resistance, Junction-to-Case (Note 2)	R <sub>θJc</sub>	1.25	°C/W	



## Electrical Characteristics (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	ition Min		Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-100	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±10	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA	-1.5	-1.9	-2.5	V
Drain Course On Chate Desintence	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-15A	-	44	58	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-15A	-	48	65	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-50V,I <sub>D</sub> =-10A	5	-	-	S
Dynamic Characteristics (Note4)	·	·				<u>.</u>
Input Capacitance	Clss	(-50)(1)(1)(-50)(1)(1)(1)(-50)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)(1)	-	8049	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =-50V,V <sub>GS</sub> =0V, F=1.0MHz	-	184.5	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	179	-	PF
Switching Characteristics (Note 4)	·	·				<u>.</u>
Turn-on Delay Time	t <sub>d(on)</sub>		-	17	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =-50V,I <sub>D</sub> =-15A	-	80	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =-10V,R <sub>GEN</sub> =9.1Ω	-	45	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	65	-	nS
Total Gate Charge	Qg		-	120	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-50V,I <sub>D</sub> =-15A, V <sub>GS</sub> =-10V	-	22	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	26.4	_	nC
Drain-Source Diode Characteristics	·					<u>.</u>
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-10A	-	-	-1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>	-	-	-	-30	А
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF =-15A	-	90	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	150	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board, t  $\leq$  10 sec.

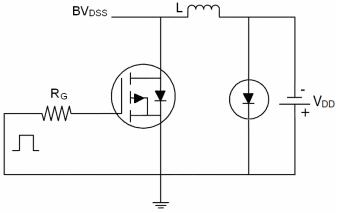
**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production

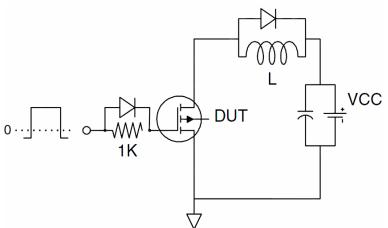


http://www.ncepower.com

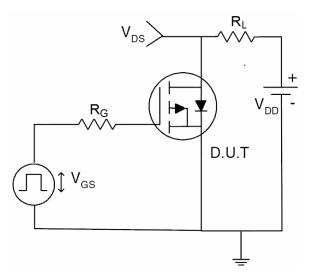
## Test Circuit 1) E<sub>AS</sub> Test Circuit



2) Gate Charge Test Circuit

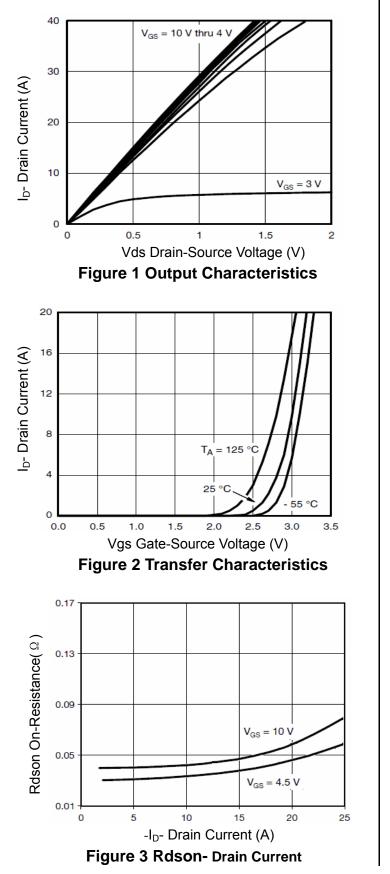


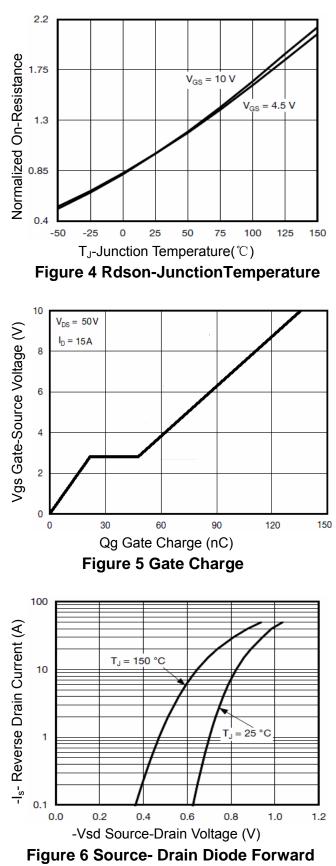
3) Switch Time Test Circuit





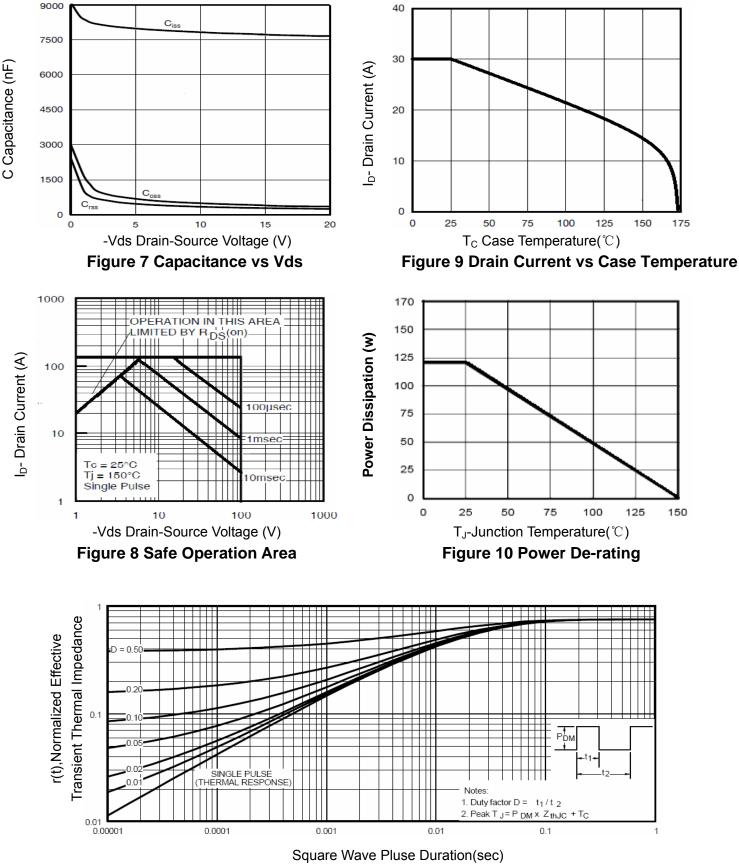
## **Typical Electrical and Thermal Characteristics (Curves)**







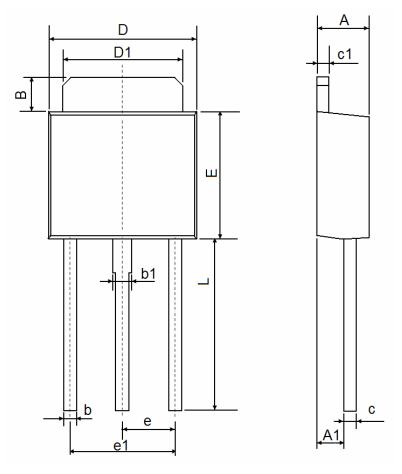
http://www.ncepower.com







# **TO-251 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
e	2.300 TYP		0.091 TYP		
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	



## Attention:

- Any and all NCE power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE power representative nearest you before using any NCE power products described or contained herein in such applications.
- NCE power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE power products described or contained herein.
- Specifications of any and all NCE power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE power products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE power product that you intend to use.
- This catalog provides information as of Sep.2010. Specifications and information herein are subject to change without notice.